

LM48410 Boomer® Audio Power Amplifier Series

Low EMI, Filterless, 2.3W Stereo Class D Audio Power Amplifier with National 3D Enhancement

General Description

The LM48410 is a single supply, high efficiency, 2.3W/channel, filterless switching audio amplifier. A low noise PWM architecture eliminates the output filter, reducing external component count, board area consumption, system cost, and simplifying design. A selectable spread spectrum modulation scheme suppresses RF emissions, further reducing the need for output filters.

The LM48410 is designed to meet the demands of mobile phones and other portable communication devices. Operating from a single 5V supply, the device is capable of delivering 2.3W/channel of continuous output power to a 4Ω load with less than 10% THD+N. Flexible power supply requirements allow operation from 2.4V to 5.5V. The LM48410 offers two logic selectable modulation schemes, fixed frequency mode, and an EMI reducing spread spectrum mode.

The LM48410 features high efficiency compared with conventional Class AB amplifiers. When driving an 8Ω speaker from a 3.6V supply, the device operates with 85% efficiency at $P_O=500$ mW/Ch. Four gain options are pin selectable through the G0 and G1 pins. The LM48410 also includes National's 3D audio enhancement that improves stereo sound quality. In devices where the left and right speakers are in close proximity, 3D enhancement affects channel specialization, widening the perceived soundstage.

Output short circuit protection prevents the device from being damaged during fault conditions. Superior click and pop suppression eliminates audible transients on power-up/down and during shutdown. Independent left/right shutdown controls maximizes power savings in mixed mono/stereo applications.

Key Specifications

 Quiescent Power Supply Current at 3.6V supply 	4mA
 Power Output at V_{DD} = 5V, R_L = 4Ω, THD ≤ 10% 	2.3W (typ)
Power Output at V _{DD} = 5V, R _L = 8Ω, THD ≤ 10%	1.5W (typ)
■ Shutdown current	0.03µA (typ)
■ Efficiency at 3.6V, 100mW into 8Ω	80% (typ)
■ Efficiency at 3.6V, 500mW into 8Ω	85% (typ)
■ Efficiency at 5V, 1W into 8Ω	86% (typ)

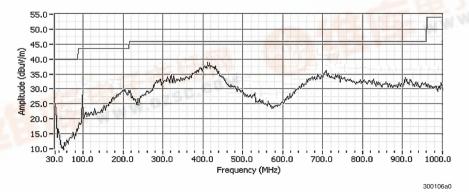
Features

- Selectable spread spectrum mode reduces EMI
- Output Short Circuit Protection
- Stereo Class D operation
- No output filter required
- National 3D Enhancement
- Logic selectable gain
- Independent channel shutdown controls
- Minimum external components
- Click and Pop suppression
- Micro-power shutdown
- Available in space-saving 4mm x 4mm LLP package

Applications

- Mobile phones
- PDAs
- Laptops

EMI Plot



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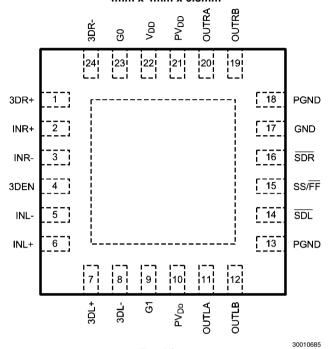
Typical Application 查询"LM48410"供应商 +2.5<u>V to +</u>5.5V C_{3D+} PV_{DD} PV_{DD} V_{DD} 3DL+ 3DR+ C_{IN} INR+ OUTRA H-BRIDGE MODULATOR GAIN INR-OUTRB CIN SDR G0 OSCILLATOR 3D G1 SDL C_{IN} OUTLA INL+ H-BRIDGE GAIN MODULATOR OUTLB INL-C_{IN} 3DEN SS/FF 3DL-3DR-PGND C_{3D}-

FIGURE 1. Typical Audio Amplifier Application Circuit

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Congestion Diagrams

LLP Package 4mm x 4mm x 0.8mm



Top View Order Number LM48410SQ See NS Package Number SQA24A

LM48410SQ Markings

UZXYTT L48410SQ

30010699

Top View
U = Wafer Fab Code
Z = Assembly Plant
XY = 2 Digit Date Code
TT = Lot Traceability
L48410SQ = LM48410SQ

Pin Descriptions 询"LM48410"供应商

<u>询"LM48410"供处</u> Pin	Name	Description	
1	3DR+	Right Channel non-inverting 3D connection. Connect to 3DL+ through C_{3D+} and R_{3D+}	
2	INR+	Right Channel Non-Inverting Input	
3	INR-	Right Channel Inverting Input	
4	3DEN	3D Enable Input	
5	INL-	Left Channel Inverting Input	
6	INL+	Left Channel Non-Inverting Input	
7	3DL+	Left Channel non-inverting 3D connection. Connect to 3DR+ through $\rm C_{3D+}$ and $\rm R_{3D+}$	
8	3DL-	Left Channel inverting 3D connection. Connect to 3DR- through $\rm C_{3D-}$ and $\rm R_{3D-}$	
9	G1	Gain Select Input 1	
10, 21	PV_{DD}	Speaker Power Supply	
11	OUTLA	Left Channel Non-Inverting Output	
12	OUTLB	Left Channel Inverting Output	
13, 18	PGND	Power Ground	
14	SDL	Left Channel Active Low Shutdown. Connect to V _{DD} for normal operation. Connect to GND to disable the left channel.	
15	SS/FF	Modulation Mode Select. Connect to $V_{\rm DD}$ for spread spectrum mode. Connect to GND for fixed frequency mode	
16	SDR	Right Channel Active Low Shutdown. Connect to V _{DD} for normal operation. Connect to GND to disable the right channel.	
17	GND	Ground	
19	OUTRB	Right Channel Inverting Output	
20	OUTRA	Right Channel Non-Inverting Output	
22	V _{DD}	Power Supply	
23	G0	Gain Select Input 0	
24	3DR-	Right Channel inverting 3D connection. Connect to 3DL- through $\rm C_{3D-}$ and $\rm R_{3D-}$	

Absolute Maximum Ratings (Notes 1, 2)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

 $\begin{array}{lll} \text{Supply Voltage (Note 1)} & 6.0 \text{V} \\ \text{Storage Temperature} & -65^{\circ}\text{C to } +150^{\circ}\text{C} \\ \text{Input Voltage} & -0.3 \text{V to V}_{\text{DD}} +0.3 \text{V} \\ \end{array}$

Power Dissipation (Note 3) Internally Limited ESD Susceptibility(Note 4) 2000V ESD Susceptibility (Note 5) 200V

Junction Temperature 150°C
Thermal Resistance

 θ_{JC} (TBD) 5.3°C/W θ_{JA} (TBD) 36.5°C/W

Operating Ratings (Notes 1, 2)

Temperature Range

 $\begin{aligned} T_{\text{MIN}} &\leq T_{\text{A}} \leq T_{\text{MAX}} & -40^{\circ}\text{C} \leq T_{\text{A}} \leq 85^{\circ}\text{C} \\ \text{Supply Voltage (V}_{\text{DD}}, \text{PV}_{\text{DD}}) & 2.4\text{V} \leq \text{V}_{\text{DD}} \leq 5.5\text{V} \end{aligned}$

Electrical Characteristics $V_{DD} = PV_{DD} = 3.6V$ (Notes 1, 2) The following specifications apply for $A_V = 6dB$, $R_L = 15\mu H + 8\Omega + 15\mu H$, $SS/\overline{FF} = V_{DD} =$ (Spread Spectrum mode), f = 1kHz, unless otherwise specified. Limits apply for $T_A = 25^{\circ}C$.

	Parameter		LM48410		
Symbol		Conditions	Typical	Limit	Units (Limits)
			(Note 6)	(Notes 7, 8)	(Lillits)
V _{os}	Differential Output Offset Voltage	$V_{IN} = 0$, $V_{DD} = 2.4V$ to 5.0V	5		mV
I _{DD}	Quiescent Power Supply Current	$V_{IN} = 0$, No Load Both channels active, $V_{DD} = 3.6V$ $V_{DD} = 5V$	4 5	6.5 8.5	mA (max)
I _{SD}	Shutdown Current	$V_{DD} = V_{SDR} = GND$	0.03	1	mA (max) μA (max)
V _{IH}	Logic Input High Voltage			1.4	V (min)
V _{IL}	Logic Input Low Voltage			0.4	V (max)
T _{WU}	Wake Up Time		4		ms
	Outhabias Farances	SS/FF = V _{DD} (Spread Spectrum)	300	390	kHz (max)
f _{SW}	Switching Frequency	SS/FF = GND (Fixed Frequency)	300		kHz
		G0, G1 = GND R _L = ∞	6	5.5 6.5	dB (min) dB (max)
A _V Gain	Gain	G0 = V _{DD} , G1 = GND	12	11.5 12.5	dB (min) dB (max)
	dalii	G0 = GND, G1 = V _{DD}	18	17.5 18.5	dB (min) dB (max)
		G0, G1 = V _{DD}	24	23.5 24.5	dB (min) dB (max)
		$A_V = 6dB$	160		kΩ
R _{IN}		$A_V = 12dB$	80		kΩ
	Input Resistance	A _V = 18dB	40		kΩ
		$A_V = 24dB$	20		kΩ

查 s 例nibd// 48410"供应麻 _{meter}		Conditions	LM48410				
	48410"供应 商 ameter		Typical	Limit	Units (Limits)		
		(Note 6)	(Notes 7, 8)	(Lillins)			
		R_L = 15μH + 4Ω + 15μH, THD ≤ 10% f = 1kHz, 22kHz BW					
		$V_{DD} = 5V$	2.3		W		
		V _{DD} = 3.6V	1.14		W		
		V _{DD} = 2.5V	490		mW		
		R_L = 15μH + 8Ω + 15μH, THD ≤ 10% f = 1kHz, 22kHz BW					
		$V_{DD} = 5V$	1.5		W		
		V _{DD} = 3.6V	740	600	mW (mir		
D	Output Power (Per Channel)	V _{DD} = 2.5V	330		mW		
P _O	Output Fower (Fer Charmer)	R_L = 15μH + 4Ω + 15μH, THD ≤ 1% f = 1kHz, 22kHz BW					
		V _{DD} = 5V	1.85		W		
		V _{DD} = 3.6V	940		mW		
		V _{DD} = 2.5V	400		mW		
		$R_{L} = 15\mu H + 8\Omega + 15\mu H, THD = 1\%$ f = 1kHz, 22kHz BW					
		$V_{DD} = 5V$	1.18		W		
		V _{DD} = 3.6V	580		mW		
		V _{DD} = 2.5V	270		mW		
THD+N	Total Harmonic Distortion	$P_O = 500$ mW/Ch, $f = 1$ kHz, $R_L = 8\Omega$	0.025		%		
		$P_O = 300$ mW/Ch, $f = 1$ kHz, $R_L = 8\Omega$	0.07		%		
PSRR	Power Supply Rejection Ratio	$V_{RIPPLE} = 200 \text{mV}_{P.P} \text{ Sine},$ Inputs AC GND, $C_{IN} = 1 \mu \text{F}$, input referred					
		f _{Ripple} = 217Hz	70		dB		
		$f_{Ripple} = 1kHz,$	68		dB		
CMRR	Common Mode Rejection Ratio	$V_{RIPPLE} = 1V_{P-P}$ $f_{RIPPLE} = 217Hz$	65		dB		
η	Efficiency	$P_O = 1W/Ch, f = 1kHz,$ $R_L = 8\Omega, V_{DD} = 5V$	86		%		
Xtalk	Crosstalk	P _O = 500mW/Ch, f = 1kHz	82		dB		
SNR	Signal to Noise Ratio	$V_{DD} = 5V, P_{O} = 1W$ Fixed Frequency Mode	88		dB		
ε _{OS}	Output Noise	Input referred, Fixed Frequency Mode A-Weighted Filter	28		μV		

Note 1: All voltages are measured with respect to the ground pin, unless otherwise specified.

Note 2: Associate Maximum Ratings Indicates imits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional but do not guarantee specific performance limits. Electrical Characteristics state DC and AC electrical specifications under particular test conditions which guarantee specific performance limits. This assumes that the device is within the Operating Ratings. Specifications are not guaranteed for parameters where no limit is given, however, the typical value is a good indication of device performance.

Note 3: The maximum power dissipation must be derated at elevated temperatures and is dictated by T_{JMAX} , θ_{JA} , and the ambient temperature, T_A . The maximum allowable power dissipation is $P_{DMAX} = (T_{JMAX} - T_A)/\theta_{JA}$ or the number given in Absolute Maximum Ratings, whichever is lower.

Note 4: Human body model, 100pF discharged through a $1.5k\Omega$ resistor.

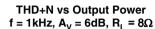
Note 5: Machine Model, 220pF-240pF discharged through all pins.

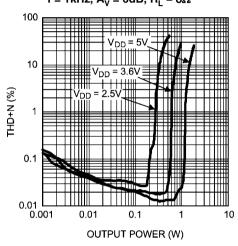
Note 6: Typicals are measured at 25°C and represent the parametric norm.

Note 7: Limits are guaranteed to National's AOQL (Average Outgoing Quality Level).

Note 8: Datasheet min/max specification limits are guaranteed by design, test, or statistical analysis.

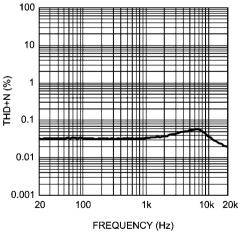
Typical Performance Characteristics





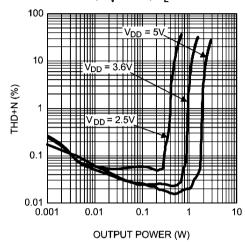
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THD+N vs Frequency $V_{DD} = 2.5V$, $P_{OUT} = 100$ mW, $R_i = 8\Omega$



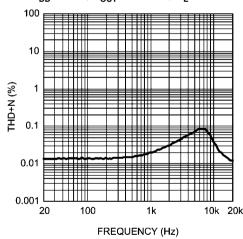
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THD+N vs Output Power f = 1kHz, $A_V = 6dB$, $R_L = 4\Omega$



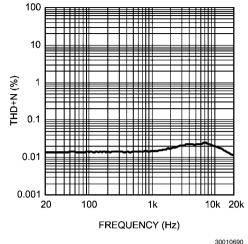
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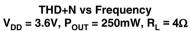
THD+N vs Frequency V_{DD} = 3.6V, P_{OUT} = 250mW, R_{L} = 8Ω

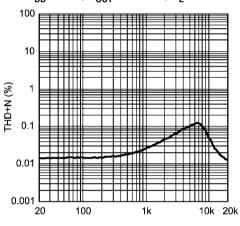


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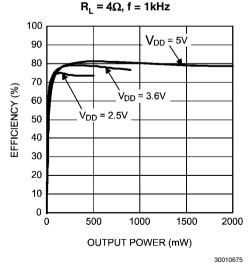




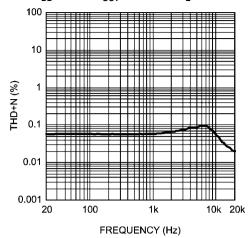


FREQUENCY (Hz) 30010692

Efficiency vs Output Power

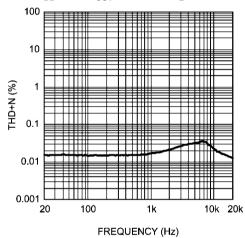


THD+N vs Frequency $\label{eq:VDD} {\rm V_{DD}=2.5V,\,P_{OUT}=100mW,\,R_L=4\Omega}$



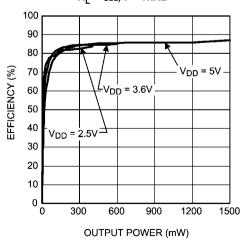
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THD+N vs Frequency $\label{eq:VDD} \mathbf{V_{DD}} = \mathbf{5V},\,\mathbf{P_{OUT}} = \mathbf{375mW},\,\mathbf{R_{L}} = \mathbf{4\Omega}$



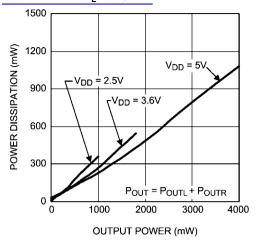
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Efficiency vs Output Power $R_1 = 8\Omega$, f = 1kHz



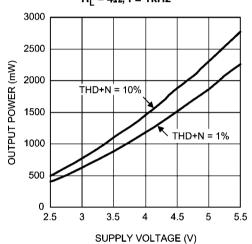
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Power Dissipation vs Output Power 查询"LM48440"集政商kHz



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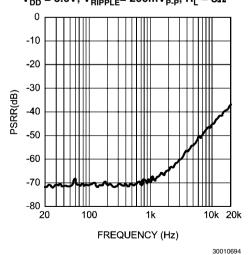
Output Power vs Supply Voltage $R_L = 4\Omega$, f = 1 kHz



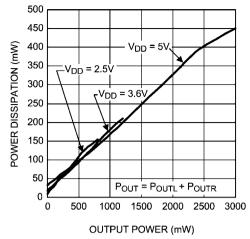
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PSRR vs Frequency V_{DD} = 3.6V, V_{RIPPLE} = 200m V_{P-P} , R_L = 8 Ω

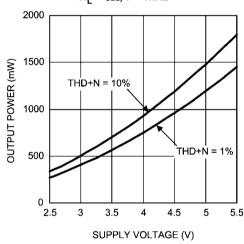


Power Dissipation vs Output Power $R_1 = 8\Omega$, f = 1kHz



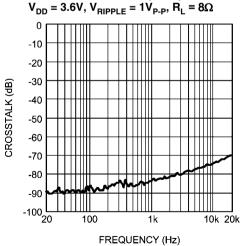
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Output Power vs Supply Voltage $R_L = 8\Omega$, f = 1kHz



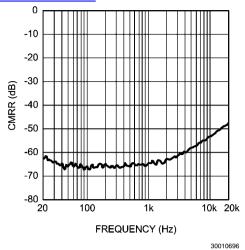
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Crosstalk vs Frequency

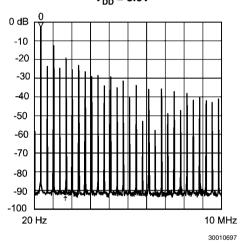


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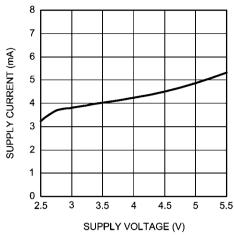
CMRR vs Frequency 查询"LM48410"战中枢域, V_{CM} = 1V_{P-P}, R_L = 8Ω



Fixed Frequency FFT $V_{DD} = 3.6V$

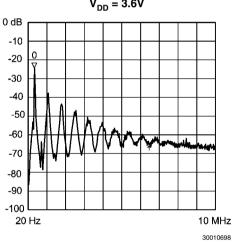


Supply Current vs Supply Voltage No Load



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$\begin{array}{c} \text{Spread Spectrum FFT} \\ \text{V}_{\text{DD}} = 3.6 \text{V} \end{array}$



Application Information 查询"LM48410"供应商

GENERAL AMPLIFIER FUNCTION

The LM48410 stereo Class D audio power amplifier features a filterless modulation scheme that reduces external component count, conserving board space and reducing system cost. The outputs of the device transition from $V_{\rm DD}$ to GND with a 300kHz switching frequency. With no signal applied, the outputs switch with a 50% duty cycle, in phase, causing the two outputs to cancel. This cancellation results in no net voltage across the speaker, thus there is no current to the load in the idle state.

When an input signal is applied, the duty cycle (pulse width) of the LM48410 output's change. For increasing output voltage, the duty cycle of one side of each output increases, while the duty cycle of the other side of each output decreases. For decreasing output voltages, the converse occurs. The difference between the two pulse widths yields the differential output voltage.

FIXED FREQUENCY MODE

The LM48410 features two modulations schemes, a fixed frequency mode and a spread spectrum mode. Select the fixed frequency mode by setting SS/FF = GND. In fixed frequency mode, the amplifier outputs switch at a constant 300kHz. In fixed frequency mode, the output spectrum consists of the fundamental and its associated harmonics (see **Typical Performance Characteristics**).

SPREAD SPECTRUM

The logic selectable spread spectrum mode eliminates the need for output filters, ferrite beads or chokes. In spread spectrum mode, the switching frequency varies randomly by 30% about a 300kHz center frequency, reducing the wideband spectral content and improving EMI emissions radiated by the speaker and associated cables and traces. A fixed frequency class D exhibits large amounts of spectral energy at multiples of the switching frequency. The spread spectrum architecture of the LM48410 spreads the same energy over a larger bandwidth (See **Typical Performance Characteristics**). The cycle-to-cycle variation of the switching period does not affect the audio reproduction, efficiency, or PSRR. Set SS/ $\overline{\text{FF}} = V_{\text{DD}}$ for spread spectrum mode.

DIFFERENTIAL AMPLIFIER EXPLANATION

As logic supplies continue to shrink, system designers are increasingly turning to differential analog signal handling to preserve signal to noise ratios with restricted voltage swings. The LM48410 features two fully differential speaker amplifiers. A differential amplifier amplifies the difference between the two input signals. Traditional audio power amplifiers have typically offered only single-ended inputs resulting in a 6dB reduction of SNR relative to differential inputs. The LM48410 also offers the possibility of DC input coupling which eliminates the input coupling capacitors. A major benefit of the fully differential amplifier is the improved common mode rejection ratio (CMRR) over single-ended input amplifiers. The increased CMRR of the differential amplifier reduces sensitivity to ground offset related noise injection, especially important in noisy systems.

POWER DISSIPATION AND EFFICIENCY

The major benefit of a Class D amplifier is increased efficiency versus a Class AB. The efficiency of the LM48410 is attributed to the region of operation of the transistors in the output stage. The Class D output stage acts as current steering switches,

consuming negligible amounts of power compared to a Class AB amplifier. Most of the power loss associated with the output stage is due to the IR loss of the MOSFET on-resistance, along with switching losses due to gate charge.

SHUTDOWN FUNCTION

The LM48410 features independent left and right channel shutdown controls, allowing each channel to be disabled independently. \overline{SDR} controls the right channel, while \overline{SDL} controls the left channel. Driving either low disables the corresponding channel, reducing supply current to $0.1\mu A$.

It is best to switch between ground and V_{DD} for minimum current consumption while in shutdown. The LM48410 may be disabled with shutdown voltages in between GND and V_{DD} , the idle current will be greater than the typical $0.1\mu A$ value.

The LM48410 shutdown inputs have internal pulldown resistors. The purpose of these resistors is to eliminate any unwanted state changes when \overline{SD} is floating. To minimize shutdown current, \overline{SD} should be driven to GND or left floating. If \overline{SD} is not driven to GND or floating, an increase in shutdown supply current will be noticed.

PROPER SELECTION OF EXTERNAL COMPONENTS

Power Supply Bypassing/Filtering

Proper power supply bypassing is important for low noise performance and high PSRR. Place the supply bypass capacitor as close to the device as possible. Typical applications employ a voltage regulator with 10µF and 0.1µF bypass capacitors that increase supply stability. These capacitors do not eliminate the need for bypassing of the LM48410 supply pins. A 1µF capacitor is recommended.

Input Capacitor Slection

Input capacitors may be required for some applications, or when the audio source is single-ended. Input capacitors block the DC component of the audio signal, eliminating any conflict between the DC component of the audio source and the bias voltage of the LM48410. The input capacitors create a high-pass filter with the input resistance $R_{\text{IN}}.$ The -3dB point of the high-pass filter is found using Equation 1 below.

$$f = 1 / 2\pi R_{IN} C_{IN}$$
 (1)

The values for $R_{\rm IN}$ can be found in the Electrical Characteristics table for each gain setting.

The input capacitors can also be used to remove low frequency content from the audio signal. Small speakers cannot reproduce, and may even be damaged by low frequencies. High-pass filtering the audio signal helps protect the speakers. When the LM48410 is using a single-ended source, power supply noise on the ground is seen as an input signal. Setting the high-pass filter point above the power supply noise frequencies, 217 Hz in a GSM phone, for example, filters out the noise such that it is not amplified and heard on the output. Capacitors with a tolerance of 10% or better are recommended for impedance matching and improved CMRR and PSRR.

National 3D Enhancement

The LM48410 features National's 3D enhancement effect that widens the perceived soundstage of a stereo audio signal. The 3D enhancement increases the apparent stereo channel separation, improving audio reproduction whenever the left and right speakers are too close to one another.

An external RC network shown in Figure 1 is required to enable the 3D effect. Because the LM48410 is a fully differential

amplifier, there are two separate RC networks, one for each the including the part of the including the including

The 3D RC network acts as a high pass filter. The amount of the 3D effect is set by the $\rm R_{3D}$ resistor. Decreasing the value of R3D increases the 3D effect. The $\rm C_{3D}$ capacitor sets the frequency at which the 3D effect occurs. Increasing the value of $\rm C_{3D}$ decreases the low frequency cutoff point, extending the 3D effect over a wider bandwidth. The low frequency cutoff point is given by:

$$f_{3D(-3dB)} = 1 / 2\pi(R_{3D})(C_{3D})$$

Enabling the 3D effect increase the gain by a factor of (1 +20k Ω /R_{3D}). Setting R_{3D} to 20k Ω results in a gain increase of 6dB whenever the 3D effect is enabled. In fully differential configuration, the component values of the two RC networks must be identical. Any component variations can affect the sound quality of the 3D effect. In single-ended configuration, only the RC network of the input pairs being driven by the audio source needs to be connected. For instance, if audio is applied to INR+ and INL+, then a 3D network must be con-

nected between 3DL+ and 3DR+. 3DL- and 3DR- can be left unconnected.

AUDIO AMPLIFIER GAIN SETTING

The LM48410 features four internally configured gain settings. The device gain is selected through the two logic inputs, G0 and G1. The gain settings are as shown in the following table.

TABLE 1.

LOGIC INPUT		GAIN		
G1	G0	V/V	dB	
0	0	2	6	
0	1	4	12	
1	0	8	18	
1	1	16	24	

SINGLE-ENDED AUDIO AMPLIFIER CONFIGURATION

The LM48410 is compatible with single-ended sources. When configured for single-ended inputs, input capacitors must be used to block and DC component at the input of the device. Figure 2 shows the typical single-ended applications circuit.

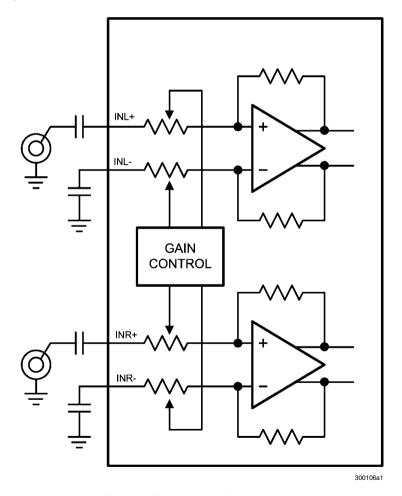


FIGURE 2. Single-Ended Circuit Diagram

PCB LAYOUT GUIDELINES

As out the load and wires) between the amplifier, load and power supply create a voltage drop. The voltage loss due to the traces between the LM48410 and the load results in lower output power and decreased efficiency. Higher trace resistance between the supply and the LM48410 has the same effect as a poorly regulated supply, increasing ripple on the supply line, and reducing peak output power. The effects of residual trace resistance increases as output current increases due to higher output power, decreased load impedance or both. To maintain the highest output voltage swing and corresponding peak output power, the PCB traces that connect the output pins to the load and the supply pins to the power supply should be as wide as possible to minimize trace resistance.

The use of power and ground planes will give the best THD +N performance. In addition to reducing trace resistance, the use of power planes creates parasitic capacitors that help to filter the power supply line.

The inductive nature of the transducer load can also result in overshoot on one or both edges, clamped by the parasitic diodes to GND and $V_{\rm DD}$ in each case. From an EMI stand-

point, this is an aggressive waveform that can radiate or conduct to other components in the system and cause interference. In is essential to keep the power and output traces short and well shielded if possible. Use of ground planes beads and micros-strip layout techniques are all useful in preventing unwanted interference.

As the distance from the LM48410 and the speaker increases, the amount of EMI radiation increases due to the output wires or traces acting as antennas. An antenna becomes a more efficient radiator with lenth. Ferrite chip inductors places close to the LM48410 outputs may be needed to reduce EMI radiation.

EXPOSED-DAP MOUNTING CONSIDERATIONS

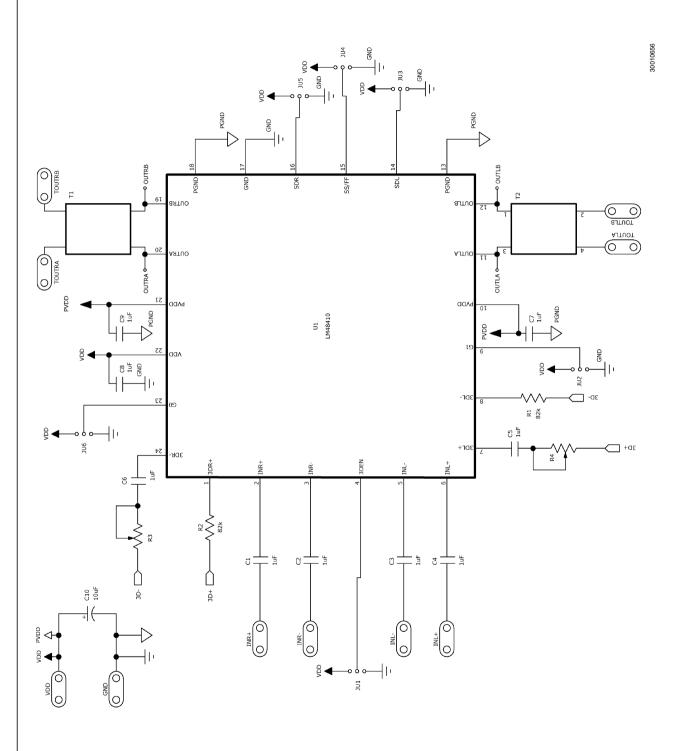
The LM48410 LLP package features an exposed thermal pad on its underside (DAP, or die attach paddle). The exposed DAP lowers the package's thermal resistance by providing a direct heat conduction path from the die to the printed circuit board. Connect the exposed thermal pad to GND though a large pad and multiple vias to a GND plane on the bottom of the PCB.

Bill of Materials 查询"LM48410"供应商

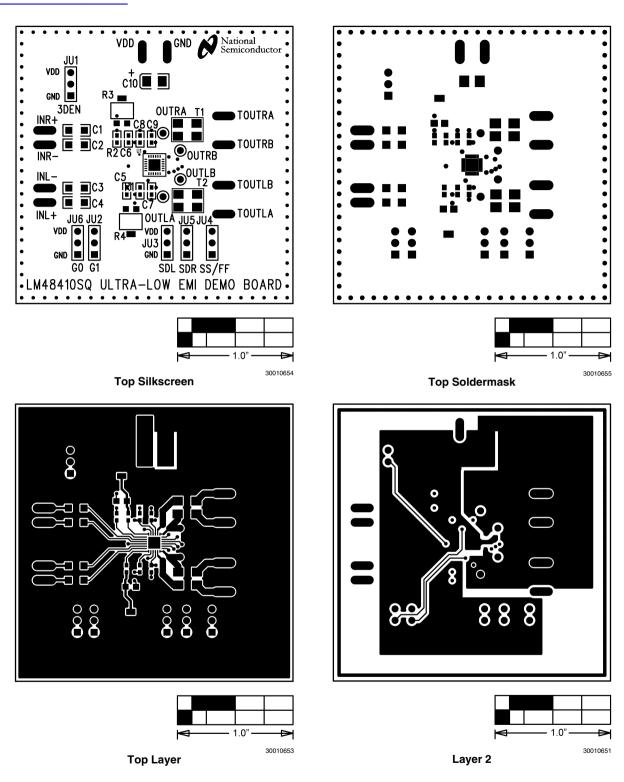
TABLE 2. LM48410SQ Demo Board Bill of Materials

Designation	Qty	Description	Recommended Manufacturer	Part Number
C1-C4	4	1μF±10%, 16V X7R ceramic capacitors (1206)	Panasonic	ECJ-3YB1C105K
C5-C9	5	1μF±10%, 16V X7R ceramic capacitors (603)	Panasonic	ECJ-1VB1C105K
C10	1	1μF±10%, 16V X7R tantalum capacitors (B-case))	AVX	TPSB106K016R0800
R1, R2	2	82kΩ±5% resistor (603)		
R3, R4	2	100kΩ potentiometer		ST4B104CT
T1, T2	2	Common mode choke, A1, 800Ω at 100HHz	TDK	ACM4532-801
JU1-JU6	6	3-pin header		
U1		LM48410SQ (24-pin SQA, 4mm x 4mm x 0.8mm)	National Semiconductor	

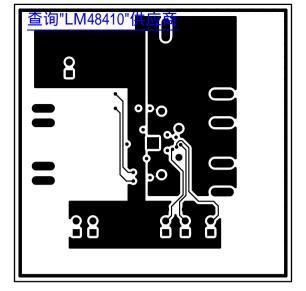
LM48410 Demonstration Board Schematic Diagram 查询"LM48410"供应商

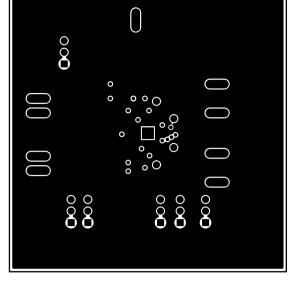


<u>த் நிடிற்ற ard நி</u>தே Layout



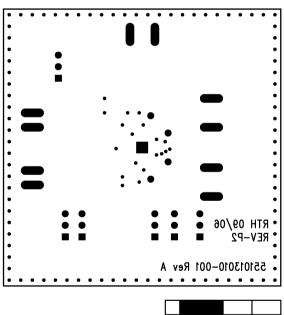
30010649





Bottom Layer





Layer 3

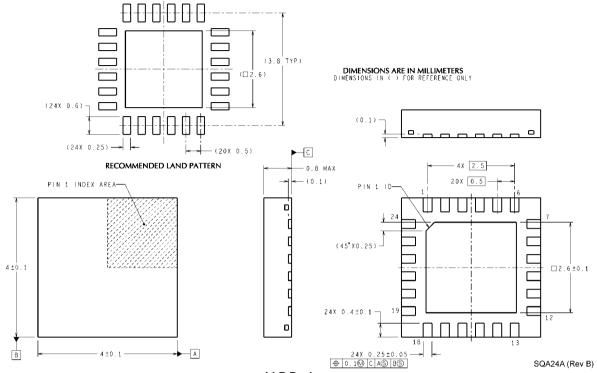
1.0"

Bottom Silkscreen

Revision Table 查询"LM48410"供应商

Rev	Date	Description	
1.0	02/21/07	Initial release.	
1.1	03/19/07	Text edits.	
1.2	07/11/07	Added the demo boards and schematic diagram.	
1.3	02/22/08	Fixed the PID (product folder).	
1.4	04/29/08	Text edits.	
1.5	07/03/08	Text edits (under SHUTDOWN FUNCTION).	

Physical Dimensions inches (millimeters) unless otherwise noted 查询"LM48410"供应商



LLP Package Order Number LM48410SQ NS Package Number SQA24A

Notes

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Clock Conditioners	www.national.com/timing	App Notes	www.national.com/appnotes	
Data Converters	www.national.com/adc	Distributors	www.national.com/contacts	
Displays	www.national.com/displays	Green Compliance	www.national.com/quality/green	
Ethernet	www.national.com/ethernet	Packaging	www.national.com/packaging	
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